

APPLICATION DATA SHEET**Inventor Information**

Inventor One Given Name	:	Tim
Family Name	:	Murphy
Postal Address Line One	:	2817 McKinney Street
City	:	Boise
State or Province	:	Idaho
County	:	Ada
Postal or Zip Code	:	83704
City of Residence	:	Boise
State or Prov. Of Residence	:	Idaho
Country of Residence	:	USA
Citizenship Country	:	USA
Inventor Two Given Name	:	Lee
Family Name	:	Gotcher
Postal Address Line One	:	3914 North Collister Drive
City	:	Boise
State or Province	:	Idaho
County	:	Ada
Postal or Zip Code	:	83703
City of Residence	:	Boise
State or Prov. Of Residence	:	Idaho
Country of Residence	:	USA
Citizenship Country	:	USA

Correspondence Information

Name Line One	:	Steven H. Arterberry, Esq.
Address Line One	:	DORSEY & WHITNEY LLP
Address Line Two	:	1420 Fifth Avenue, Suite 3400
City	:	Seattle
State or Province	:	Washington
Postal or Zip Code	:	98101
Telephone	:	206-903-8800
Facsimile	:	206-903-8820
E-Mail	:	patentseattle@dorsey.com

Application Information

Title : METHOD AND SYSTEM FOR ELECTRICALLY COUPLING A CHIP TO CHIP PACKAGE
Total Drawing Sheets : 3
Formal Drawings : YES
Application Type : Utility
Attorney Docket Number : 501039.04
Assigned : Yes (Large Entity)

Representative Information

Representative Customer No. : 27,076

Continuity Information

This application is a : divisional of
Application One : 09/978,983
Filing Date : October 15, 2001